

6/15/05

06-23-2005

FORM PTO-1595
(Rev. 10/02)

RECORDATION FORM COVER

COMMERCE
mark Office

Docket No.: 071971-0268

PATENTS ONLY

103026329

To the Honorable Commissioner for Patents and Trademarks: Please record the attached original documents or copy thereto:

1. Name of Conveying Party(ies):

Hideyuki ARAI, Takashi NAKABAYASHI, Takashi OHTSUKA

Additional name(s) of conveying party(ies) attached? ☐ Yes ☐ No

3. Nature of Conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ Other

Execution Date: June 6, 2005, June 6, 2005, June 6, 2005

2. Name and address of receiving party(ies):

Name: MATSUSHITA ELECTRIC INDUSTRIAL CO., LTD.

Address: 1006, Oaza Kadoma,
Kadoma-shi,
Osaka 571-8501 JAPANAdditional name(s) & address(es) attached? ☐ Yes ☐ No112959 U.S. PTO
11/152109

061506

4. Application number(s) or patent number(s):

If the document is being filed together with a new application, the execution date of the application is: June 6, 2005,
June 6, 2005,
June 6, 2005

A. Patent Application No(s).

B. Patent No(s).

Additional numbers attached? ☐ Yes ☐ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: MCDERMOTT WILL & EMERY LLP

Internal Address:

Street Address: 600 13th Street, N.W.

City: Washington State: D. C. Zip: 20005-3096

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41)

\$40.00

☐ Enclosed☒ Authorized to be charged to deposit account

8. Deposit account number:

500417

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Michael E. Fogarty, 36,139

June 15, 2005

Name and Registration No. of Person Signing

Signature

Date

Total number of pages including cover sheet: 3

OMB No. 0651-0027 (exp. 6/30/2005)

06/22/2005 ECDOPER 00000163 500417 11152109

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40.00 DA

PATENT
REEL: 016702 FRAME: 0223

Attorney Docket No. _____

ASSIGNMENT

WHEREAS, Hideyuki ARAI, Takashi NAKABAYASHI, Takashi OHTSUKA
hereinafter designated as the undersigned) has (have) invented certain new and useful improvements in
SEMICONDUCTOR MEMORY AND METHOD FOR MANUFACTURING THE SAME
for which the undersigned has (have):

- (a) filed an application for Letters Patent of the United States of America on
_____ having Serial No. _____; or
- (b) executed an application for Letters Patent of the United States of America on the date(s)
indicated below; and

WHEREAS, Matsushita Electric Industrial Co., Ltd. of
1006, Oaza Kadoma, Kadoma-shi, Osaka 571-8501, Japan
its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is
desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters
Patent(s) that may be granted therefor in the United States of America;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to the undersigned in
hand paid, the receipt of which is hereby acknowledged, and other good and valuable consideration, the
undersigned has (have) sold, assigned and transferred, and by these presents do sell, assign and transfer
unto the Assignee the full and exclusive right to the said invention in the United States of America and
its territories and for all foreign countries, dependencies and possessions and the entire right, title and
interest in and to the application and any and all Letters Patent(s) which may be granted therefor in the
United States of America and its territories, dependencies and possessions, and in and to any and all
divisions, reissues, continuations and extensions thereof for the full term or terms for which the same
may be granted.

The undersigned agree(s) to execute all papers necessary in connection with this application
and any continuing, divisional or reissue applications thereof and also to execute separate assignments
in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference
which may be declared concerning this application or any continuation, division or reissue thereof or
Letters Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way
possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which
may be necessary in connection with claims under or provisions of the International Convention for the
Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent(s) to the Assignee and to vest all rights therein hereby conveyed to the Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents and Trademarks to issue any and all Letters Patents of the United States of America resulting from said application or any division or divisions or continuing or reissue applications thereof to the Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

This Assignment has been executed by the undersigned on the date(s) indicated.

Date: June 6, 2005, Hideyuki Arai
Hideyuki ARAI

Date: June 6, 2005, Takashi Nakabayashi
Takashi NAKABAYASHI

Date: June 6, 2005, Takashi Ohtsuka
Takashi OHTSUKA

Date: _____, _____

Date: _____, _____

Date: _____, _____

Date: _____, _____

Date: _____, _____